

SLOVENSKI STANDARD
oSIST prEN IEC 62037-7:2026
01-marec-2026

Pasivne radiofrekvenčne (RF) in mikrovalovne naprave, meritve intermodulacijskega nivoja - 7. del: Terenska merjenja pasivne intermodulacije

Passive RF and microwave devices, intermodulation level measurement - Part 7: Field measurements of passive intermodulation

iTeh Standards

Dispositifs RF et à micro-ondes passifs, mesure du niveau d'intermodulation - Partie 7: Mesures de l'intermodulation passive sur le terrain

Document Preview

Ta slovenski standard je istoveten z: prEN IEC 62037-7:2026

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ICS:

33.120.01	Komponente in pribor na splošno	Components and accessories in general
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en



46/1075/CDV

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IEC TC 46 : CABLES, WIRES, WAVEGUIDES, RF CONNECTORS, RF AND MICROWAVE PASSIVE COMPONENTS AND ACCESSORIES

SECRETARIAT:

United States of America

SECRETARY:

Mr David Hess

OF INTEREST TO THE FOLLOWING COMMITTEES:

SC 46A, SC 46F

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ASPECTS CONCERNED:

Electromagnetic Compatibility

 SUBMITTED FOR CENELEC PARALLEL VOTING NOT SUBMITTED FOR CENELEC PARALLEL VOTING

Attention IEC-CENELEC parallel voting

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Draft Preview

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TITLE:

Passive RF and microwave devices, intermodulation level measurement – Part 7: Field measurements of passive intermodulation

PROPOSED STABILITY DATE: 2030

NOTE FROM TC/SC OFFICERS:

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INTERMODULATION LEVEL MEASUREMENT –****Part 7: Field measurements of passive intermodulation****FOREWORD**

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